

Bioclimatic approach to assessing the potential impact of climate change on wheat midge (Diptera: Cecidomyiidae) in North America — CORRIGENDUM

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An error was published in Table 1, bottom row of column three. The corrected text “Minimum

degree-days above DV0 to complete one generation” (not two generations) is presented in the modified table below.

Table 1. Values for parameter settings for the CLIMEX® model for projecting distribution and relative abundance of *Sitodiplosis mosellana* in Europe and North America.

Index	Parameter	Description	Value
Temperature	DV0	Limiting low temperature	5 °C
	DV1	Lower optimal temperature	16 °C
	DV2	Upper optimal temperature	24 °C
	DV3	Limiting high temperature	28 °C
Moisture	SM0	Limiting low soil moisture	0.2
	SM1	Lower optimal soil moisture	0.3
	SM2	Upper optimal soil moisture	0.9
	SM3	Limiting high soil moisture	1.25
Diapause	DPD0	Diapause induction day length	13
	DPT0	Diapause induction temperature	3
	DPT1	Diapause termination temperature	3
	DPD	Diapause development days	120
Cold stress	DPSW	Diapause indicator for winter diapause	0
	TTCS	Cold stress threshold	-22 °C
Heat stress	THCS	Cold stress temperature rate	-0.004
	THHS	Heat stress temperature threshold	34
Dry stress	THHS	Heat stress temperature rate	0.05
	SMDA	Dry stress threshold	0.10
Wet stress	HDS	Dry stress rate	-0.01
	SMWS	Wet stress threshold	1.5
Degree-days above DV0	HWS	Wet stress rate	0.0005
	DV0		5
	DV3		30
	MTS	Model step time	7
Degree-days above DVCS	DV3		6.5
	DV4		100
	MTS	Model step time	7
	DVCS		
Degree-days above DVHS	DV4		
	MTS	Model step time	
	DVCS		30
	DV4		100
Degree-days per generation	MTS		7
	PDD	Minimum degree-days above DV0 to complete one generation	1135

Reference

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